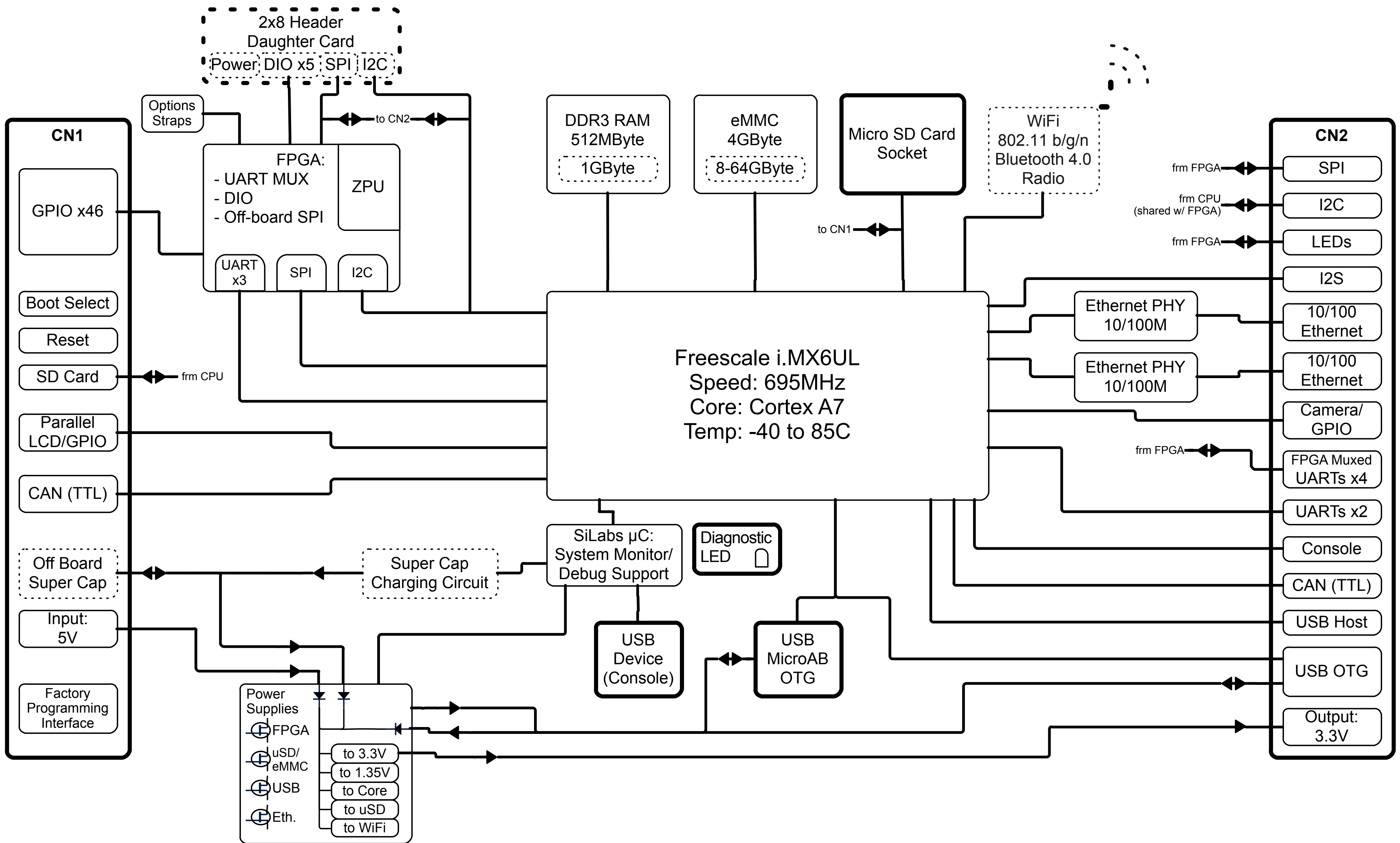


# TS-4100 Rev B



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# Standard Options

Option 1	TS-4100-SMN1I	NXP i.MX6UL 695MHz ARM Cortex A7 512MB DDR3 RAM and 4GB eMMC Flash, (-40 to 85C)
	TS-4100-SMN2I	NXP i.MX6UL 695MHz ARM Cortex A7 512MB DDR3 RAM and 4GB eMMC Flash, Stand Alone w/ Daughter Card support (-40 to 85C)
Option 2	TS-4100-SMW5I	NXP i.MX6UL 695MHz ARM Cortex A7 512B DDR3 RAM and 4GB eMMC Flash, TS-SILO, WiFi/Bluetooth w/Chip antenna, (-40 to 85C)
Option 3	TS-4100-SRW9I	NXP i.MX6UL 695MHz ARM Cortex A7 1GB DDR3 RAM and 4GB eMMC Flash, TS-SILO, WiFi/Bluetooth w/Chip antenna, (-40 to 85C)
	TS-4100-SRW8I	NXP i.MX6UL 695MHz ARM Cortex A7 1GB DDR3 RAM and 4GB eMMC Flash, TS-SILO, WiFi/Bluetooth w/Chip antenna, Stand Alone w/ Daughter Card support (-40 to 85C)

# Optional Components/Features Summary

All Parts are Industrial Temp

**WiFi/Bluetooth Option  
w/ Chip Antenna**  
 U.FL available on request  
 Included only on xxx5x, xxx8x, xxx9x Standard Option  
 ADD: K2 (chip antenna)  
 (alternate: U.FL antenna connector)

**1 GByte RAM Option**  
 Included only on xRx8x, xRx9x Standard Option  
 REMOVE: U23 4Gbit Die  
 ADD: U23 8Gbit Die

**TS-SILO Option**  
 Included only on xxx5x, xxx8x, xxx9x Standard Option  
 ADD: U16, U9,  
 REMOVE: R37

**Daughter Card Option**  
 Makes an SBC configuration  
 w/ header for expansion  
 Included only on xxx2x, xxx8x, Standard Option  
 ADD: HD1

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# Rev.A to Rev B Changes

SiLab Power\_FAIL needs series resistor to CPU (when no 3.3V present)

Change FPGA 3.3V to be always ON

Add 2 resistor straps for total of 4

AN\_SCAP\_1 should be going to CN2\_87 (error on Rev.A)

ETH\_PHY\_IRQ should not be connected on either PHY chip

PHY should use FPGA DIO for Reset = "soft reset"

Make it easy to have SuperCaps on the base board

Add series resistor in 6UL\_RESET#

Remove U19 (FPGA reset IC)

Must be able to switch power to eMMC

Add ID pin to identify Rev.B - PD on SPI MOSI

Add OFF\_BD\_RESET# 47K PD res

Remove U18 - PHY now using soft reset

Isolate CPU 3.3V current using R22

Change CAM\_VCC rail to isolated 3.3V

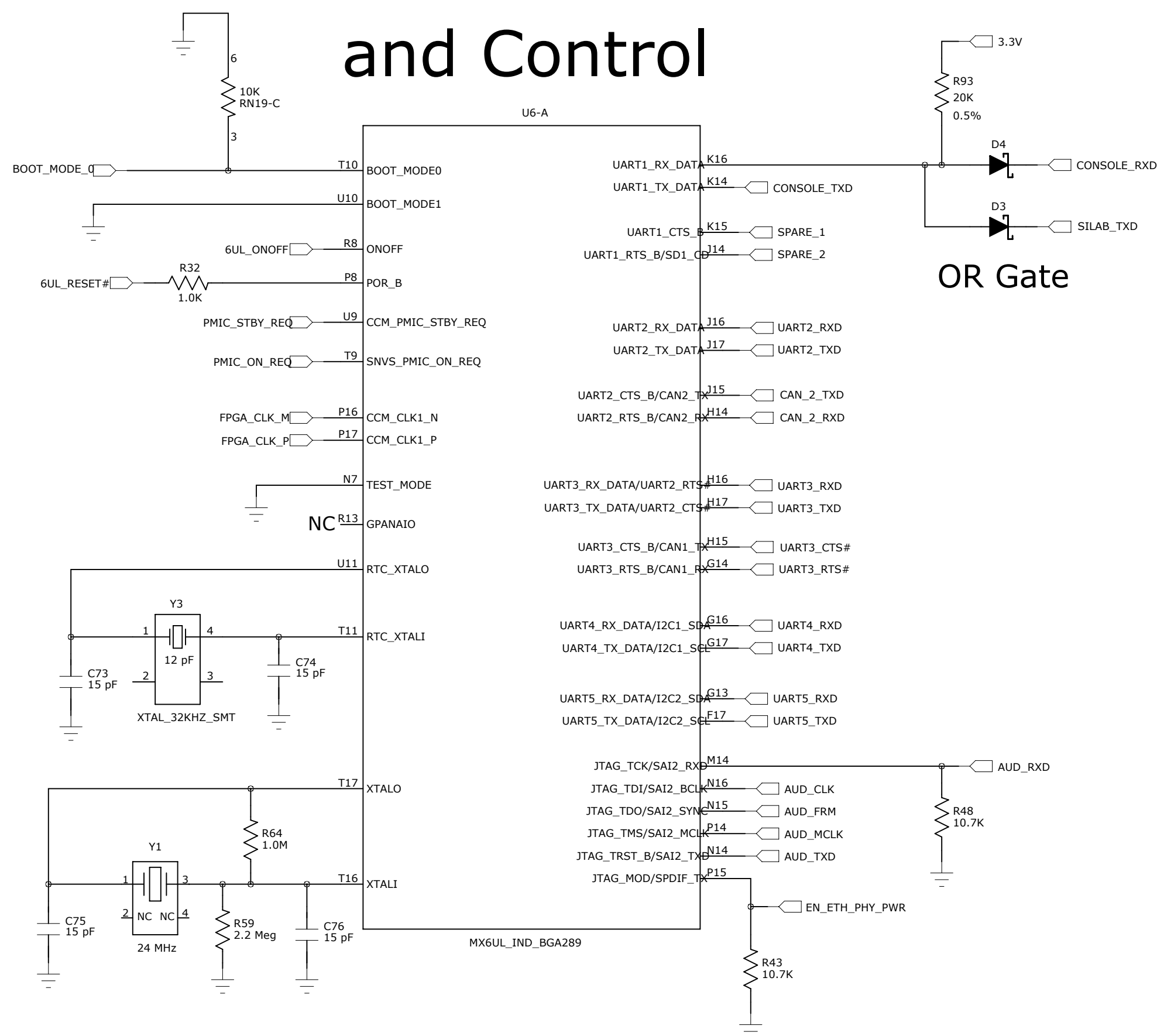
Change C47 to 470 pF 0603 ?

Move "No CHRГ" jumper to CPU or FPGA - Change CN1-17 to SPARE\_1

Remove K1 and R33 (no more 24 MHz Osc) - use Xtal instead

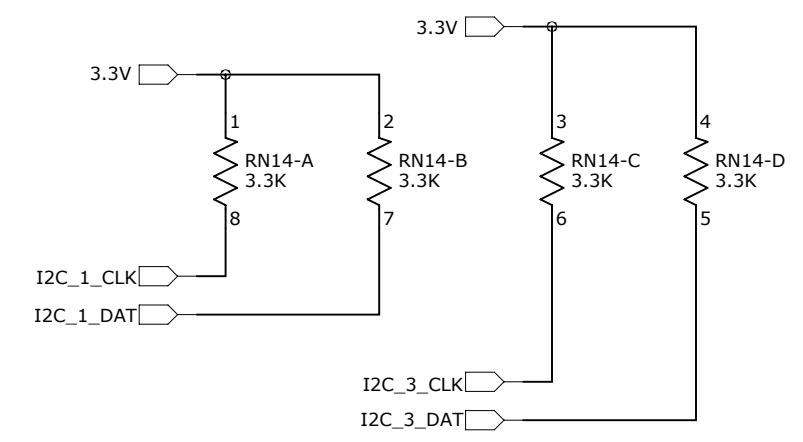
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# 6UL UART and Control

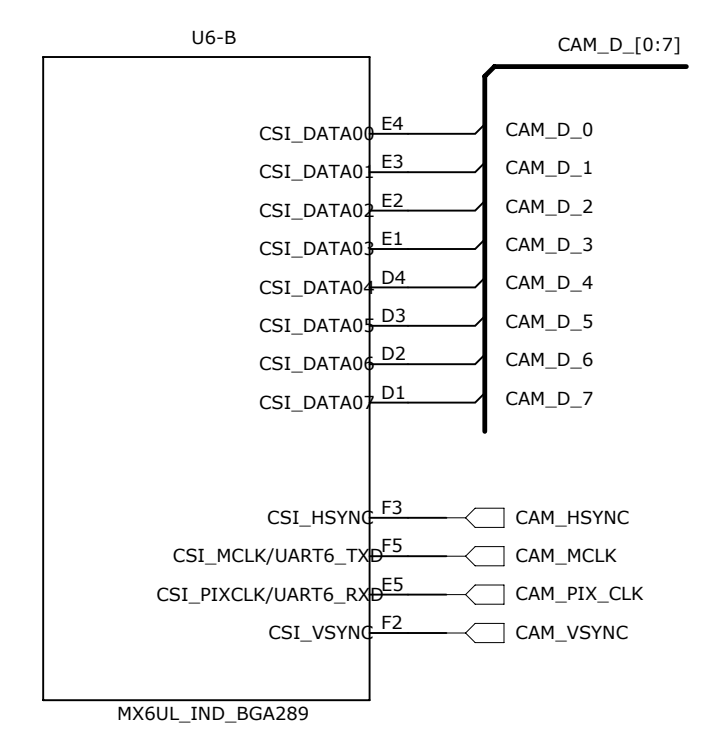


24 MHz  
Osc.

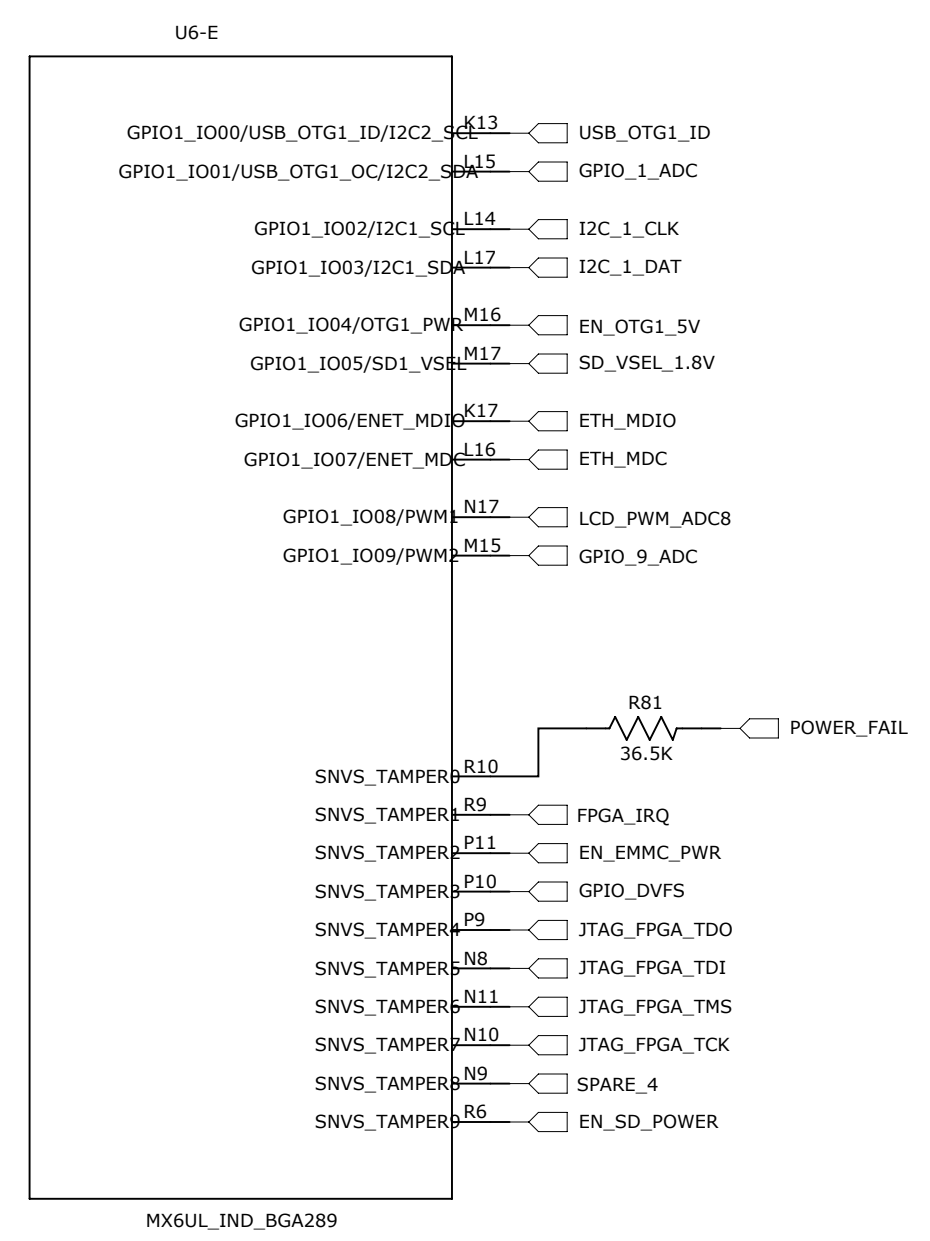
## I2C PU Res.



# 6UL Camera

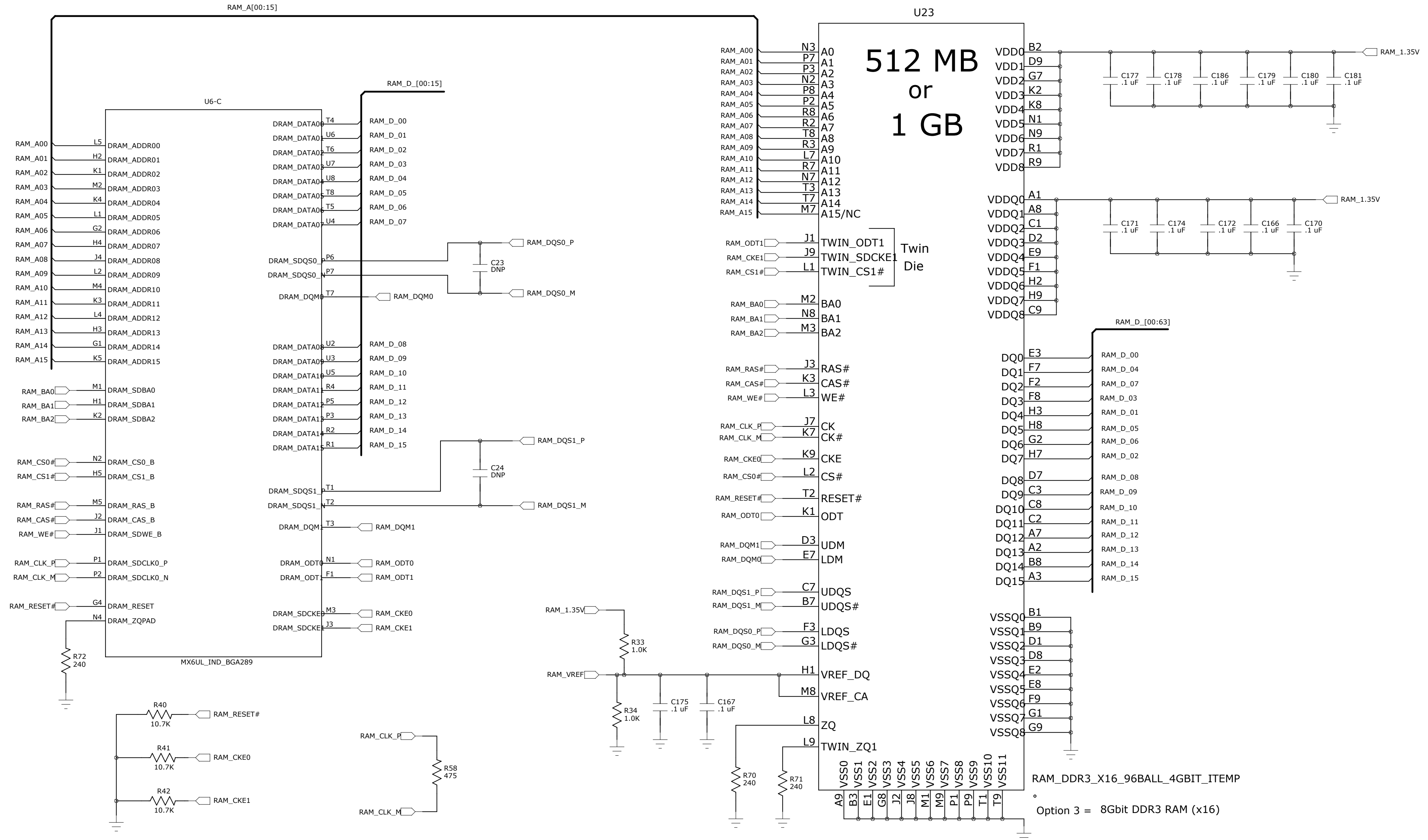


# 6UL DIO

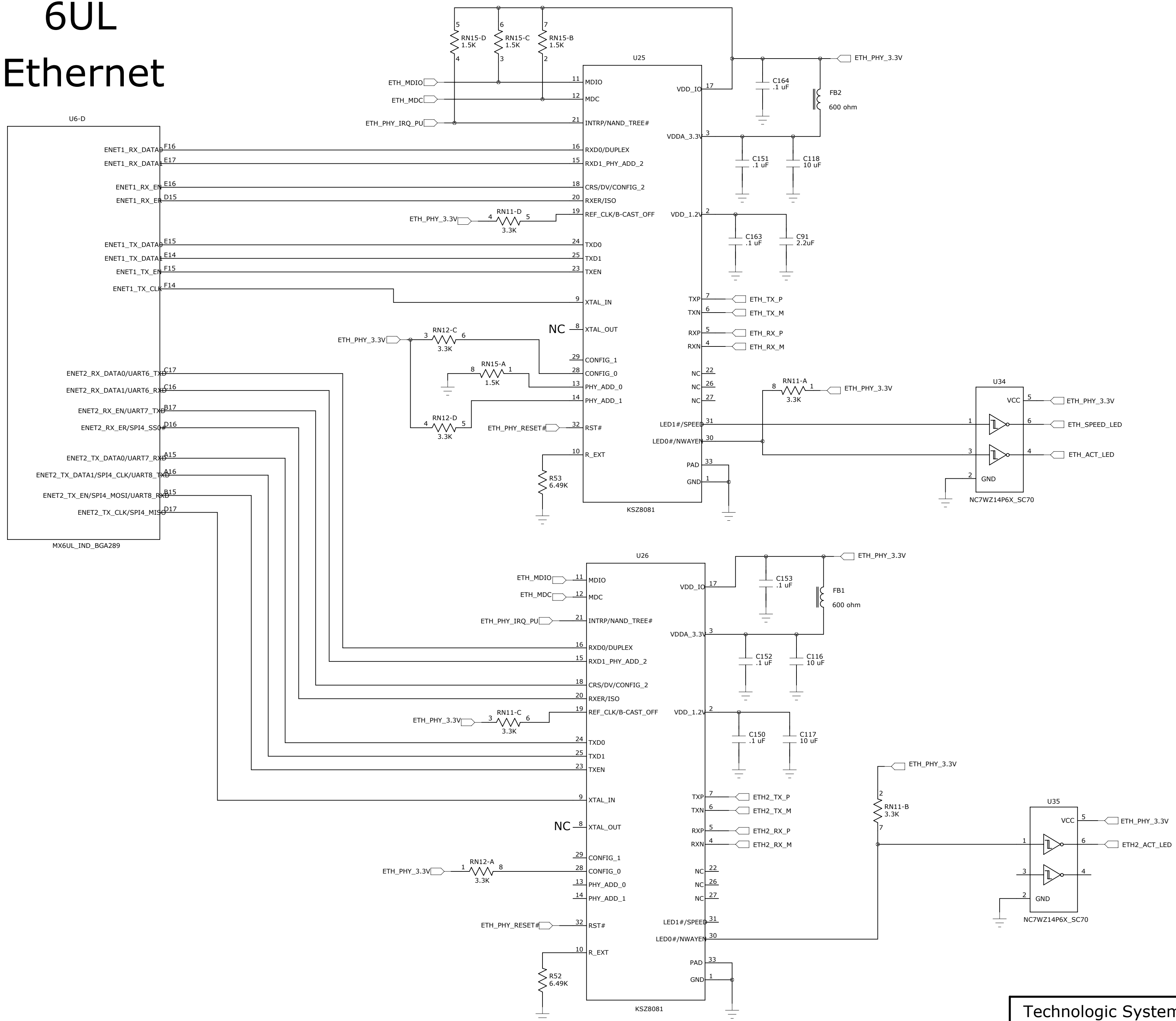


# 6UL RAM Interface

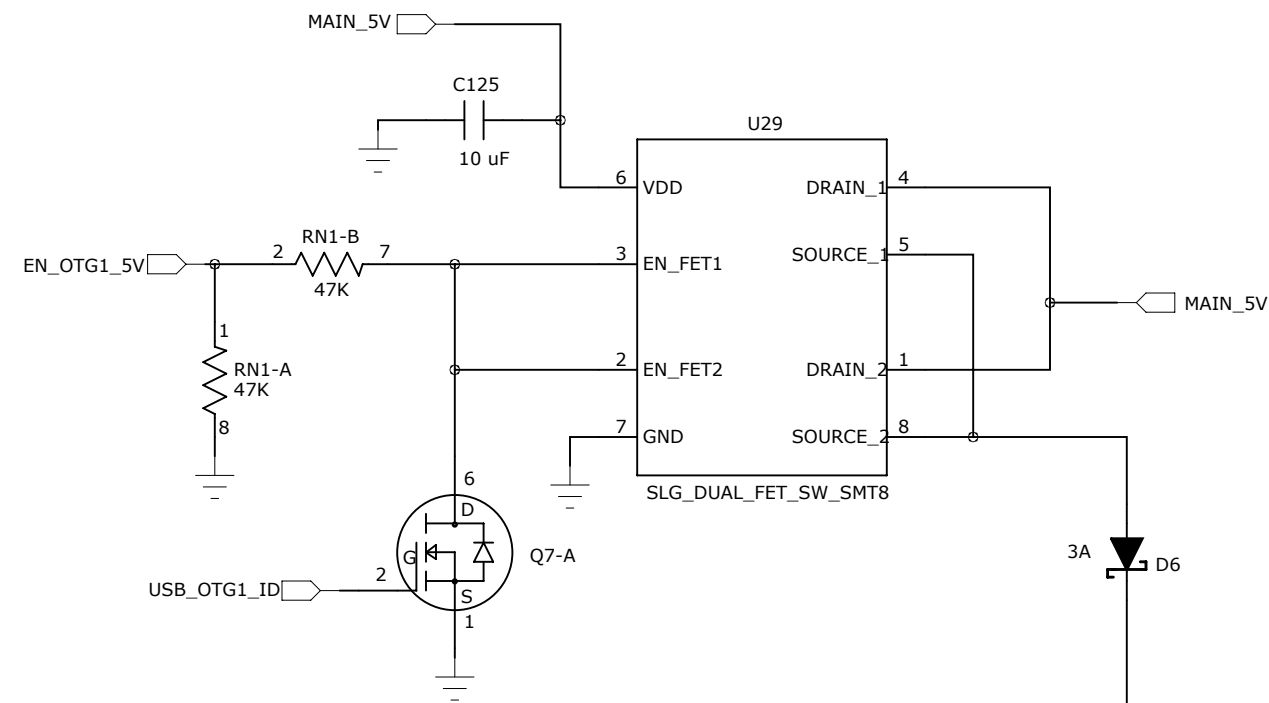
# DDR3 RAM



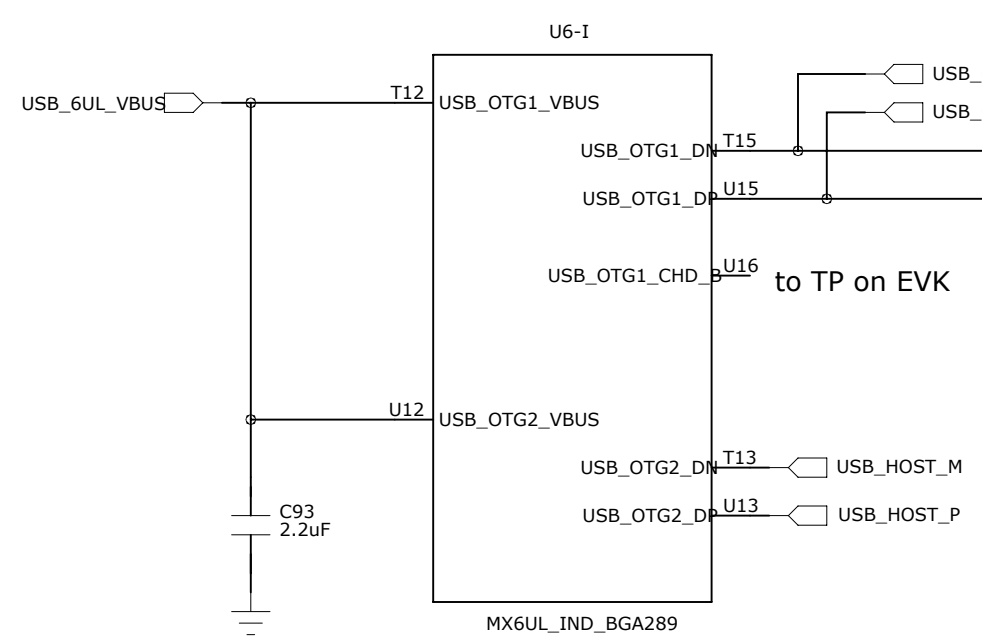
# 6UL Ethernet



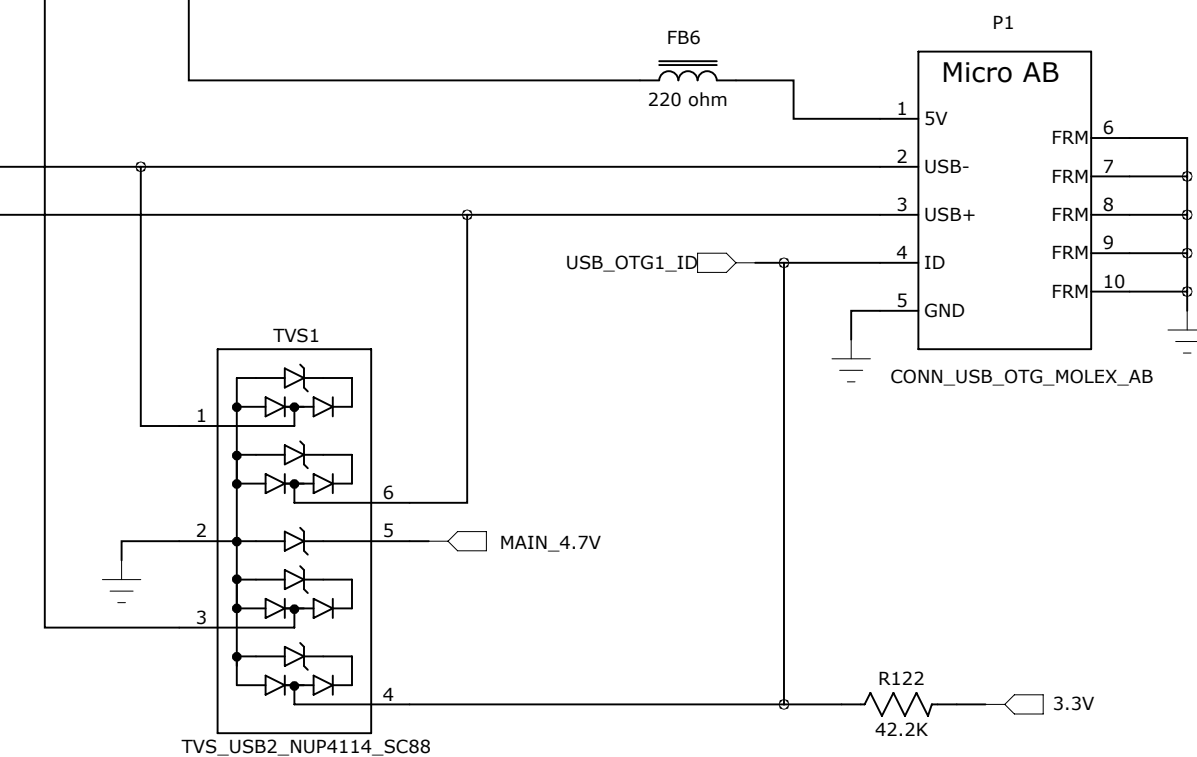
# USB 5V Switch



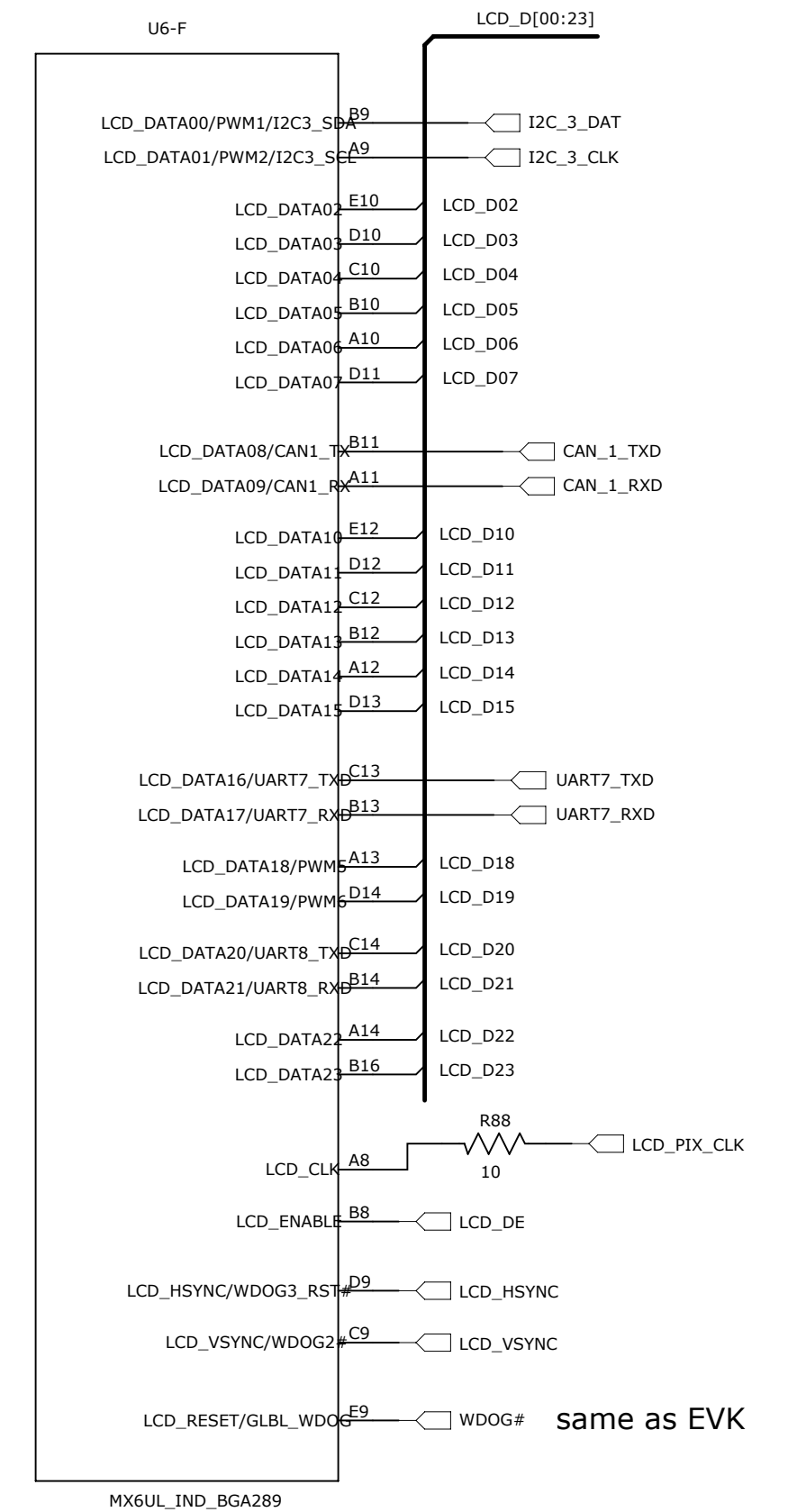
# 6UL USB Ports



# USB OTG Micro AB



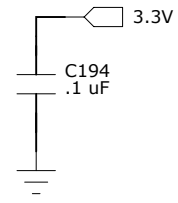
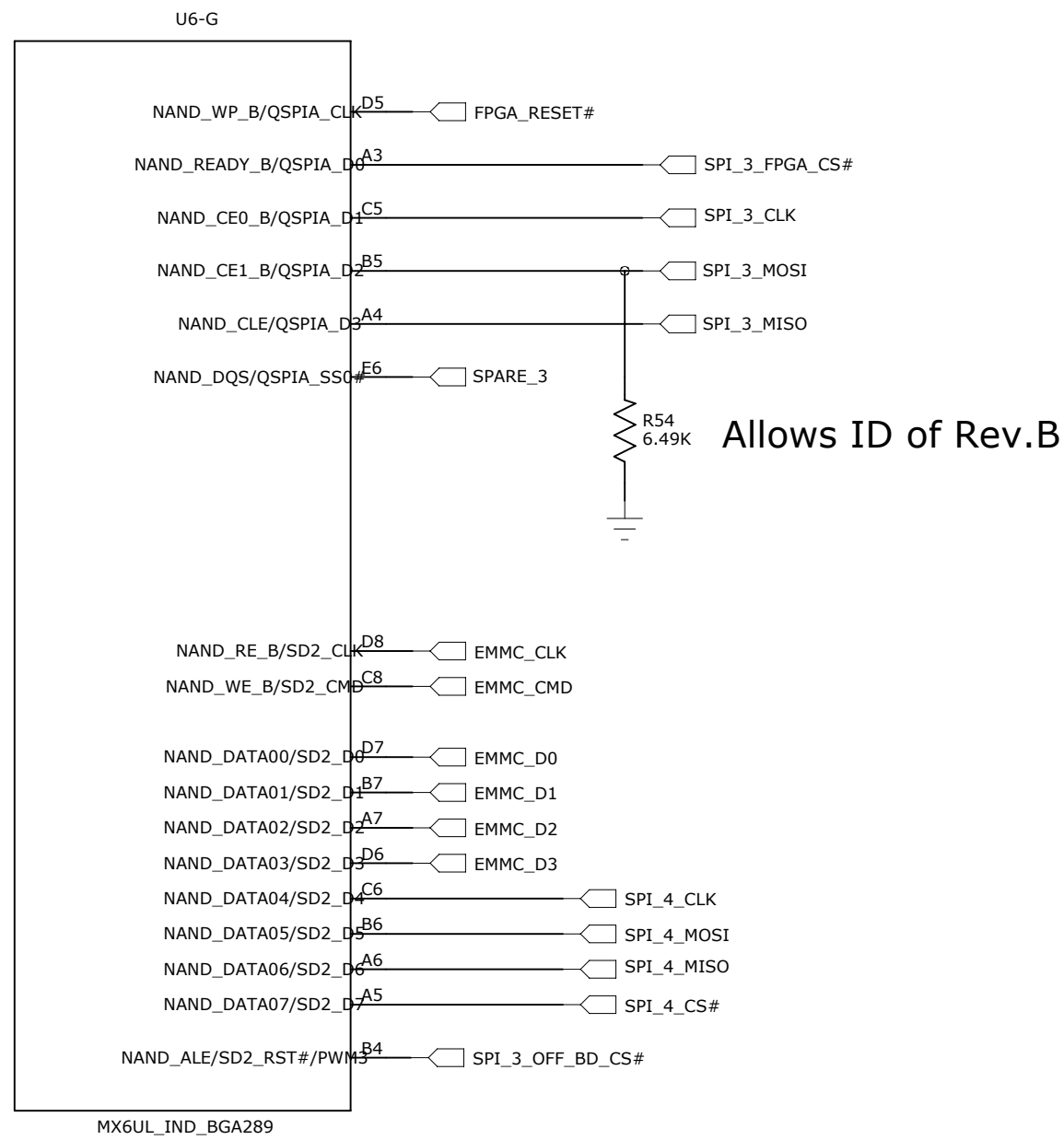
# 6UL LCD



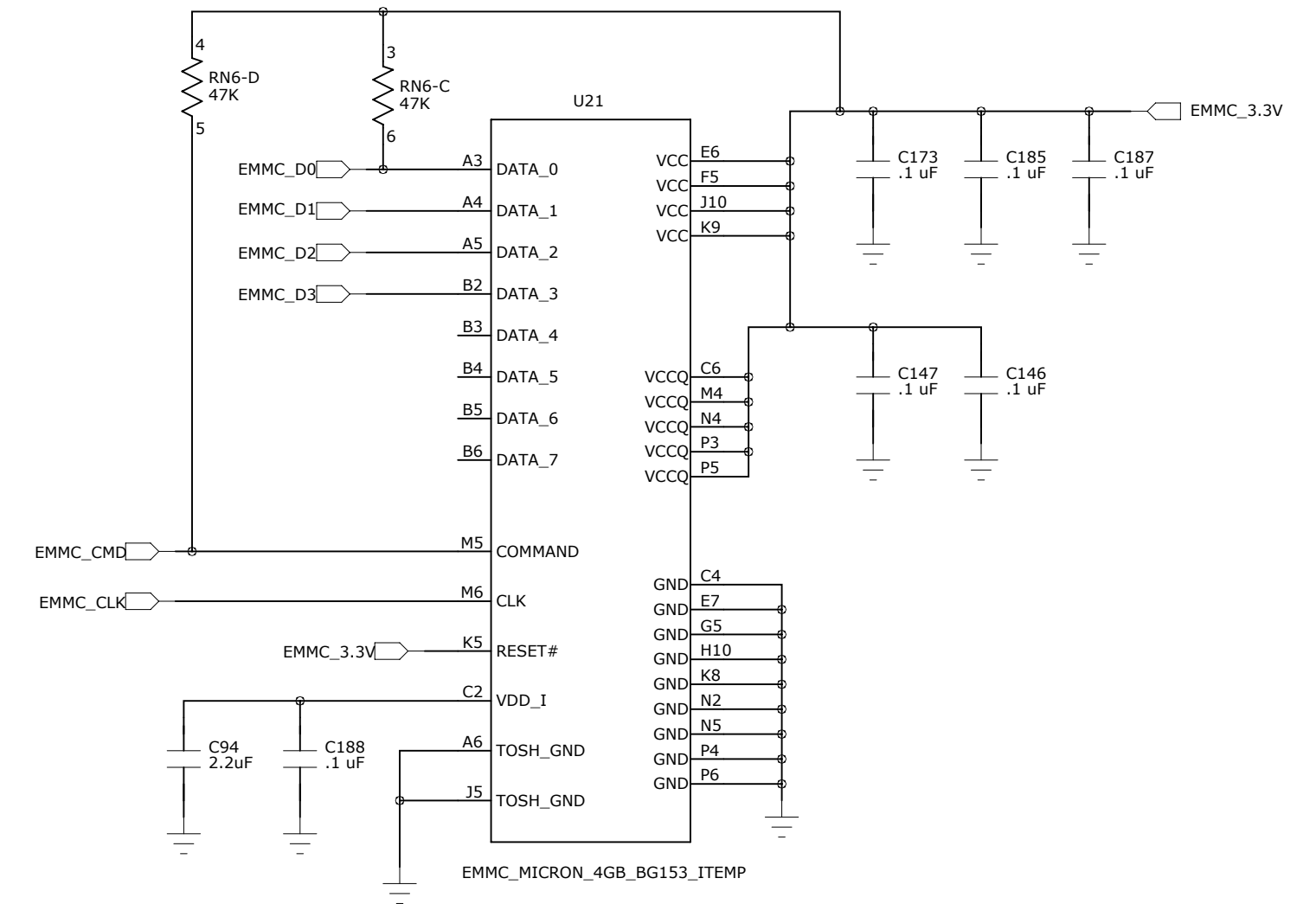
Host USB 5V comes from 5V switch  
Turns on when 3.3V present  
directly drives Host USB port  
and also drives USB\_OTG2\_VBUS ball

OTG1\_VBUS comes up from BB.  
It is gated off until 3.3V present  
It also goes thru a diode

# 6UL Flash

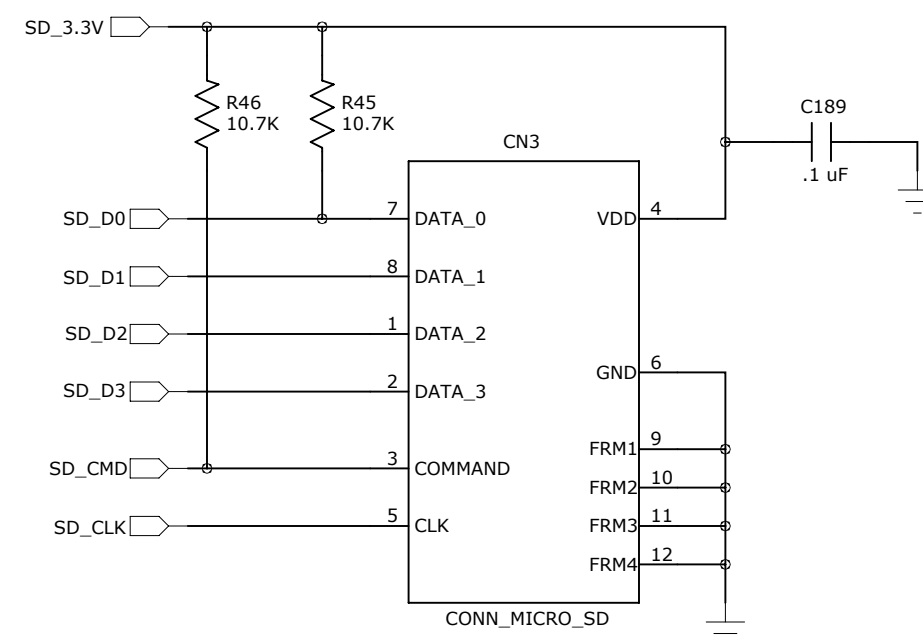
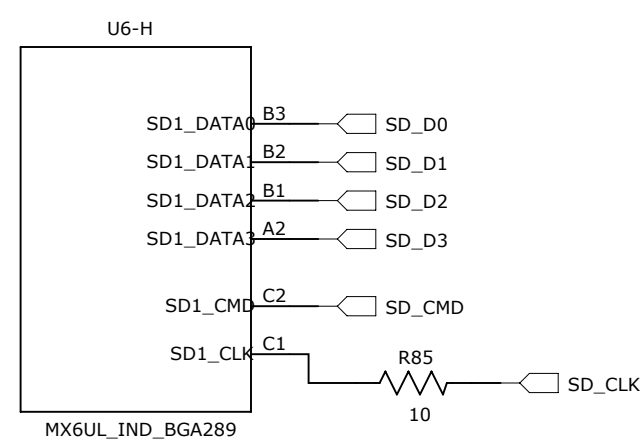


# eMMC 4GB (optional: up to 64GB)



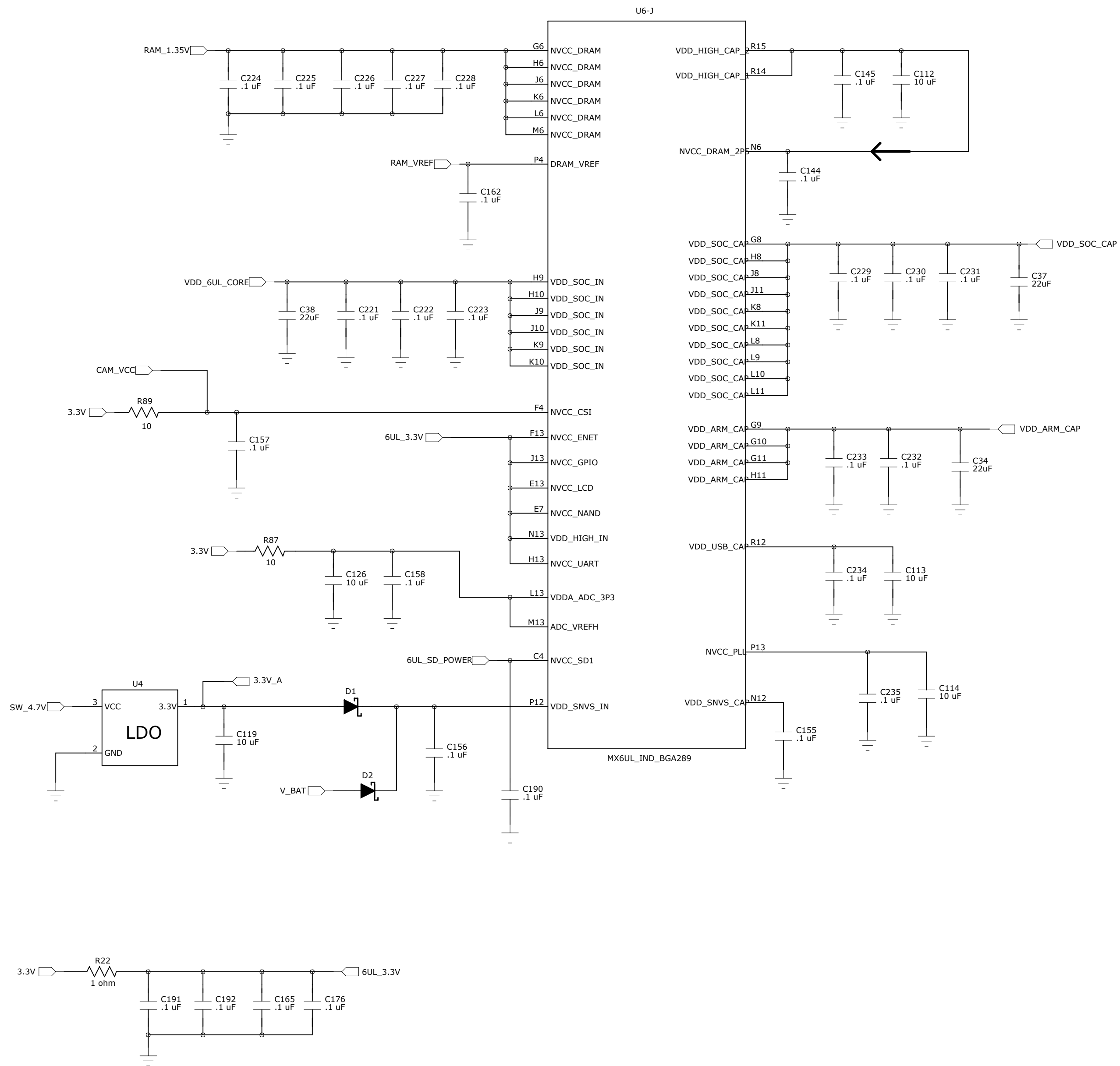
# Micro SD Card Socket

# 6UL SDIO

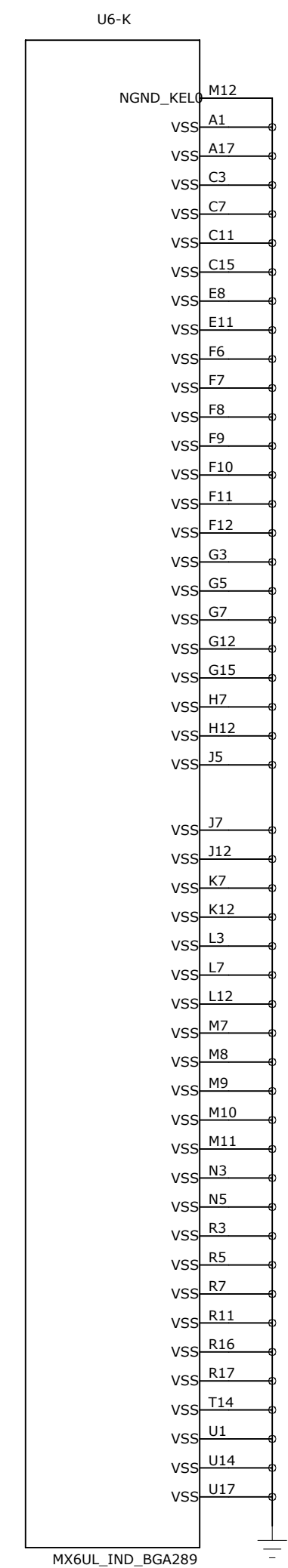




# 6UL Power



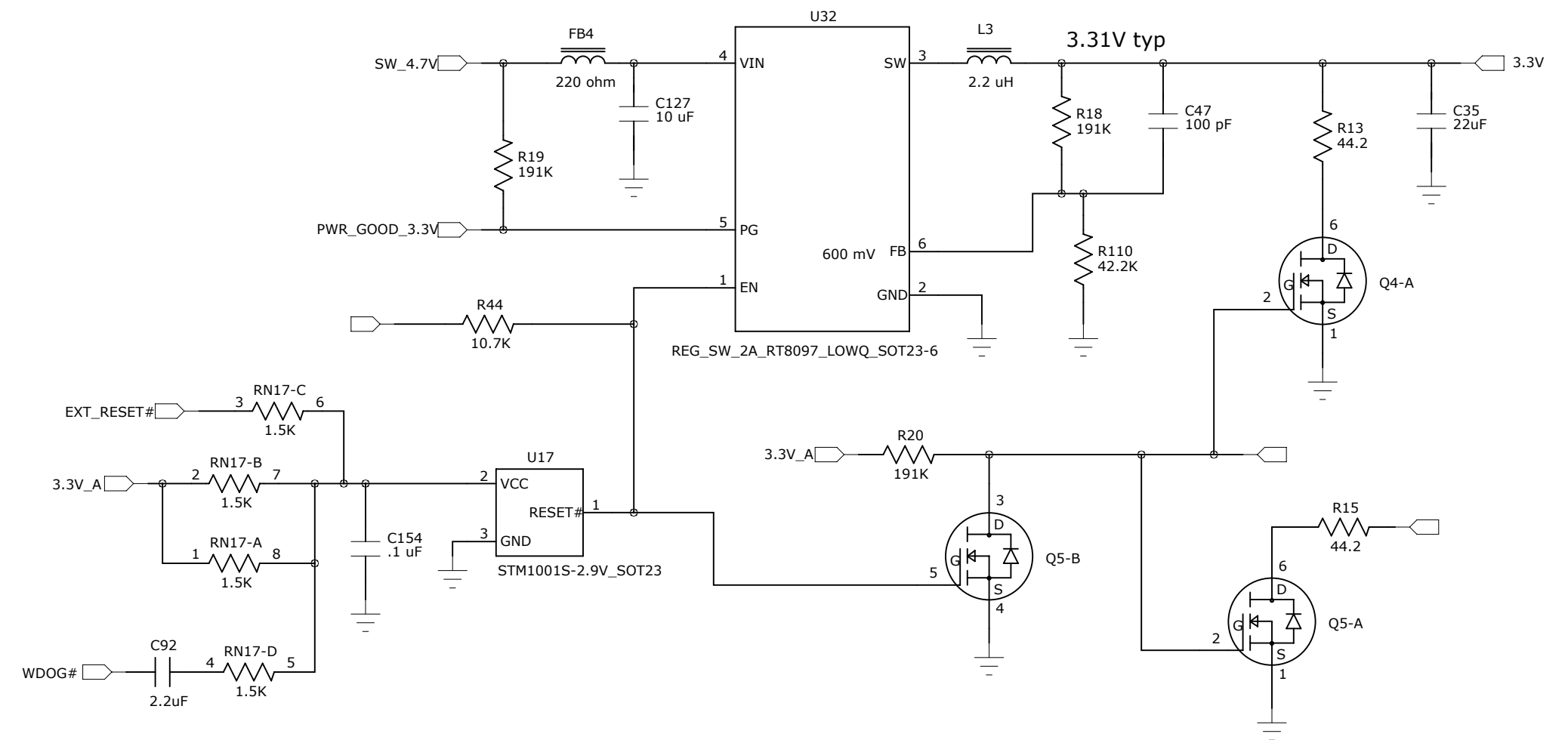
# 6UL GND



# SD Card 1A Reg 1.8V or 3.2V

3.3V --> 6UL\_SD\_POWER

# 3.3V 2A Reg



# CPU Core 1A Reg

SW\_4.7V --> DCC\_6UL\_CORE

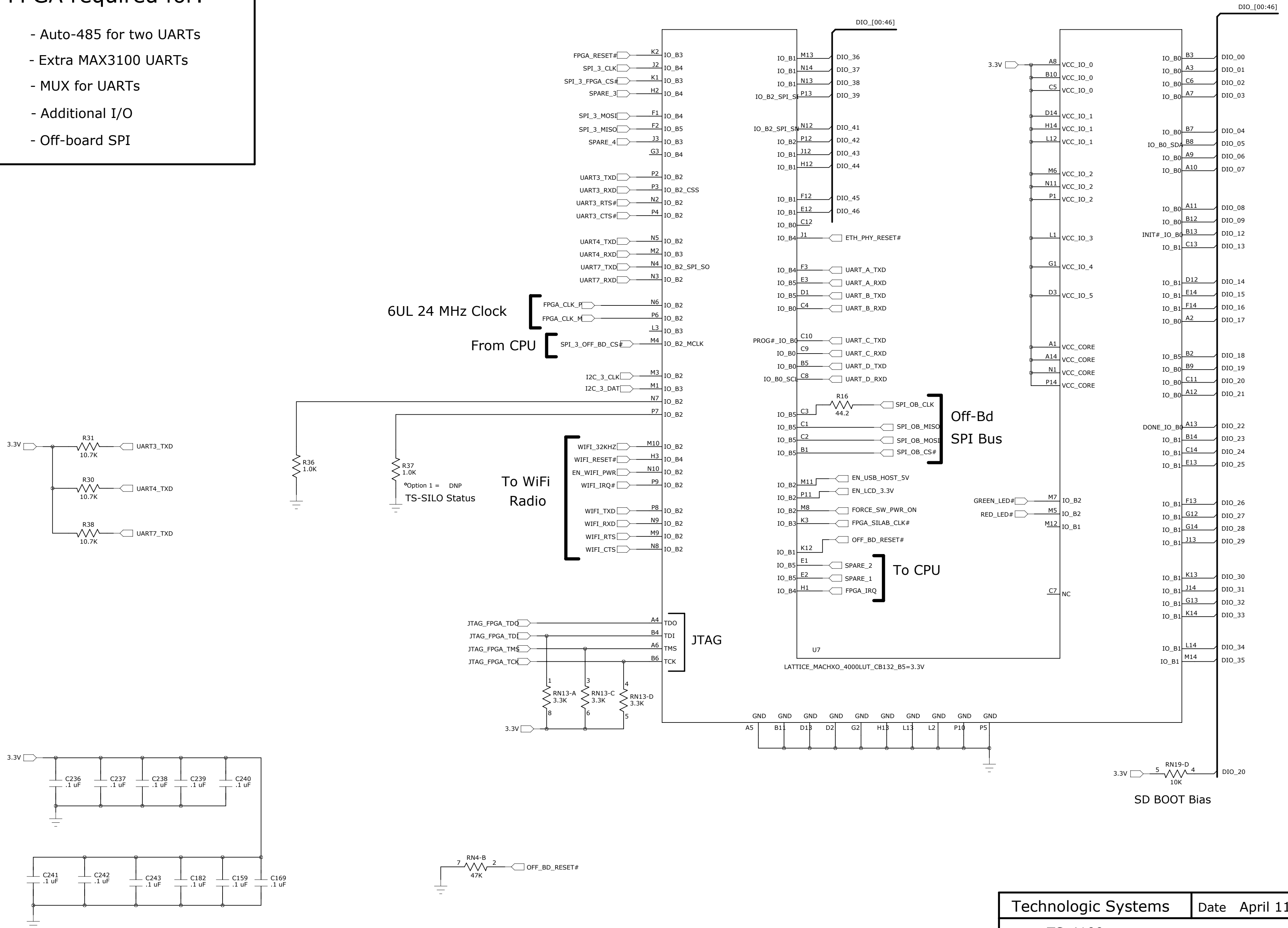
# RAM 1.35V 1A Reg

SW\_4.7V --> RAM\_1.35V

# MACH XO2 FPGA

## FPGA required for:

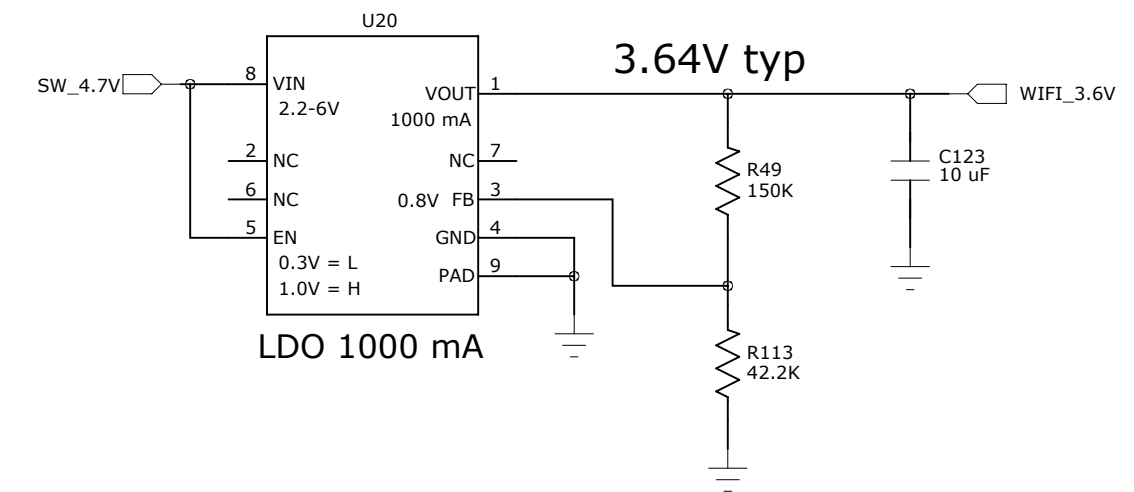
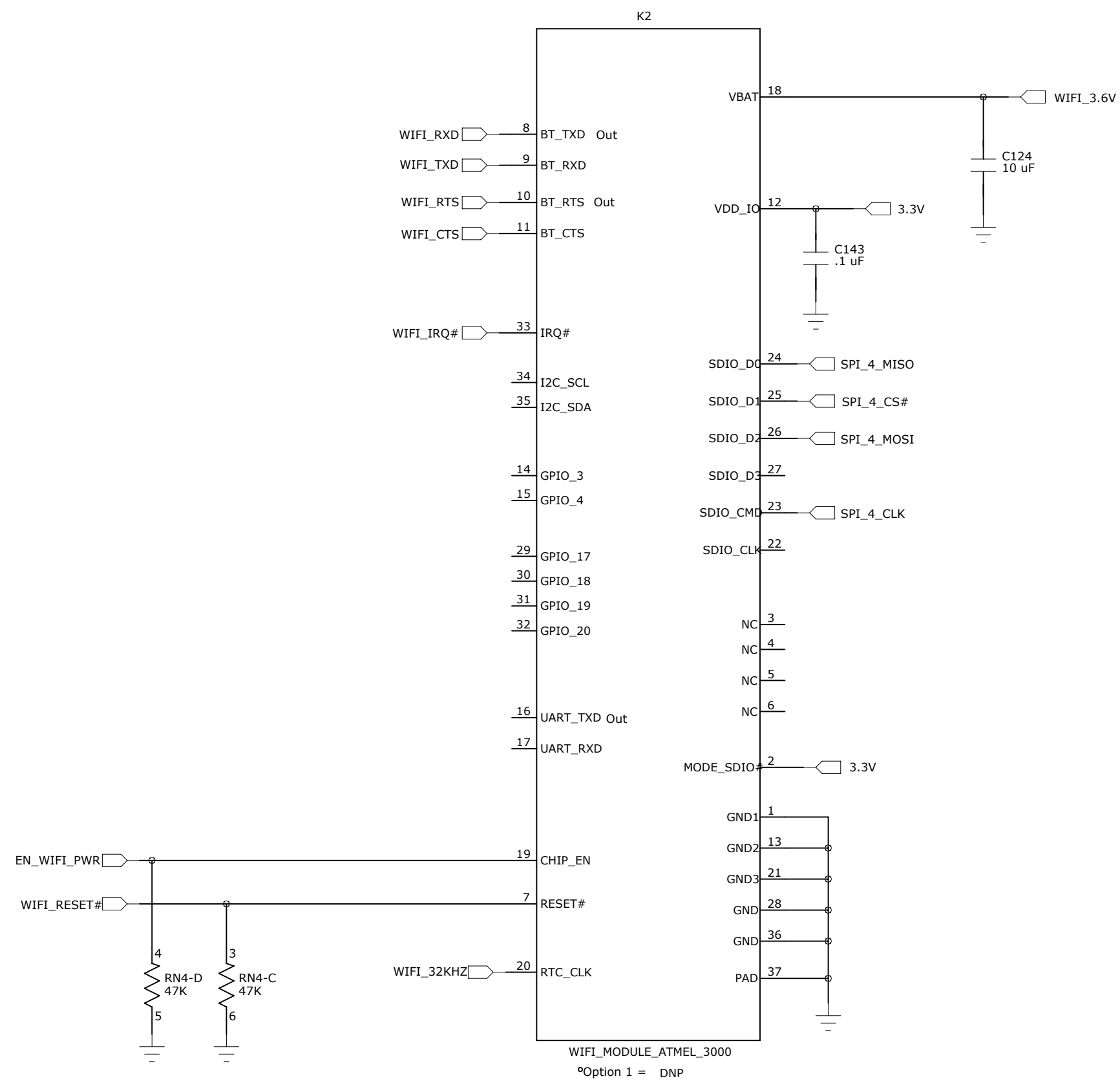
- Auto-485 for two UARTs
- Extra MAX3100 UARTs
- MUX for UARTs
- Additional I/O
- Off-board SPI



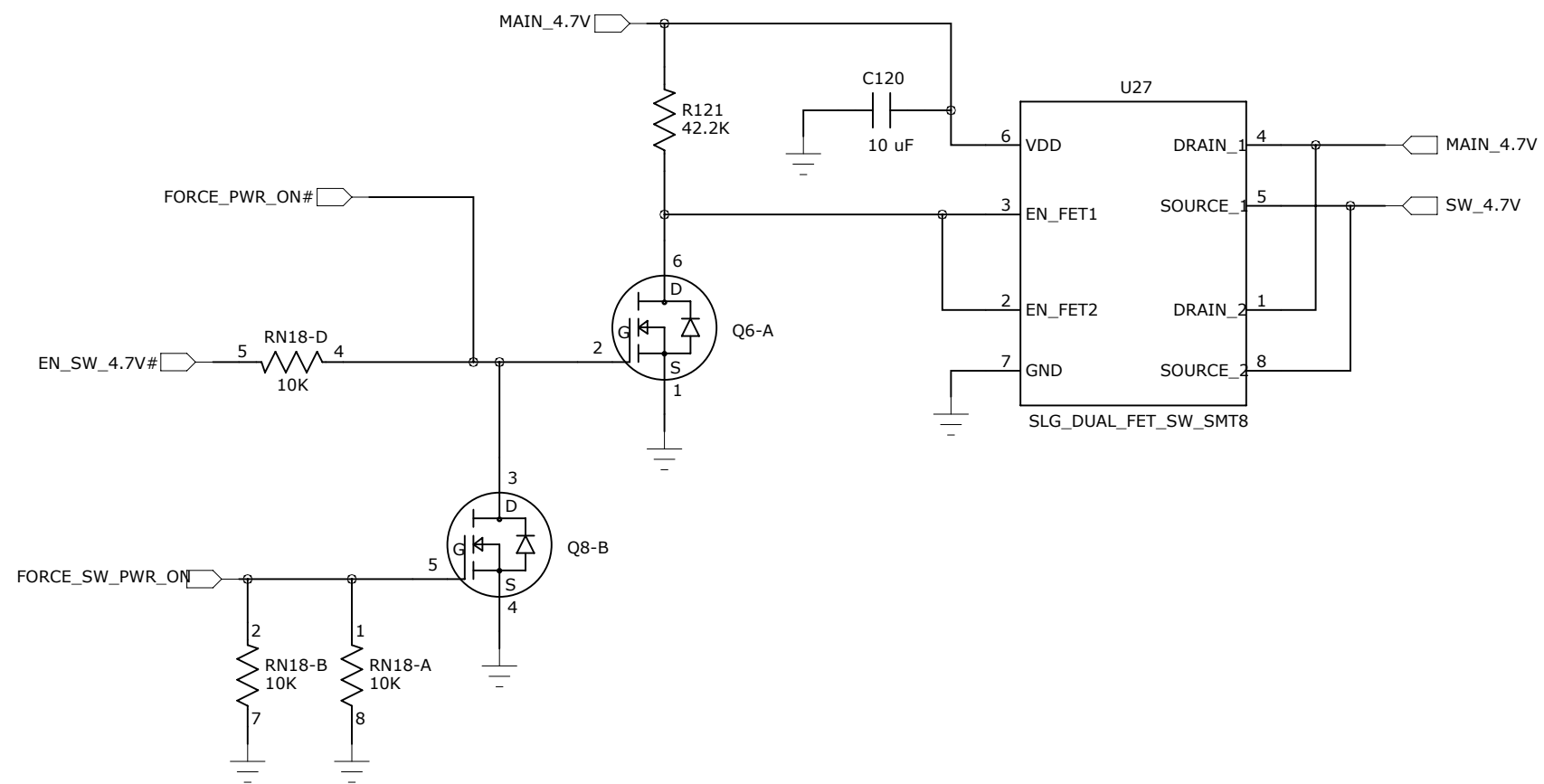
# WiFi

## WiFi / Bluetooth Radio Module

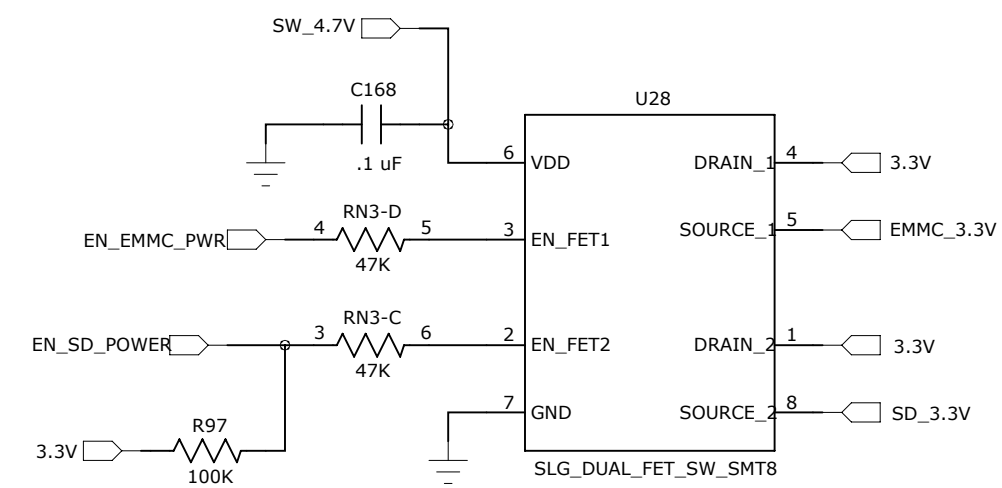
## WiFi 3.6V Regulator



## Main 4.7V Power Sw.

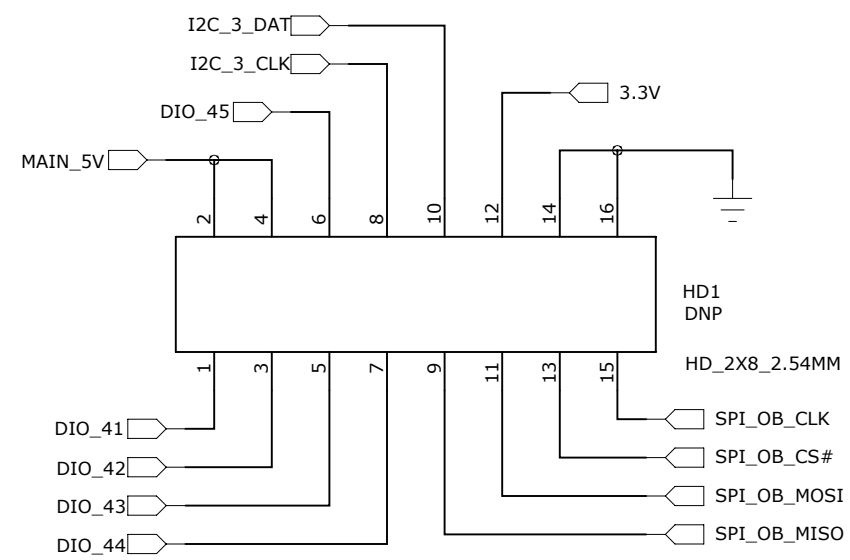


## eMMC and SD Card Power Sw.

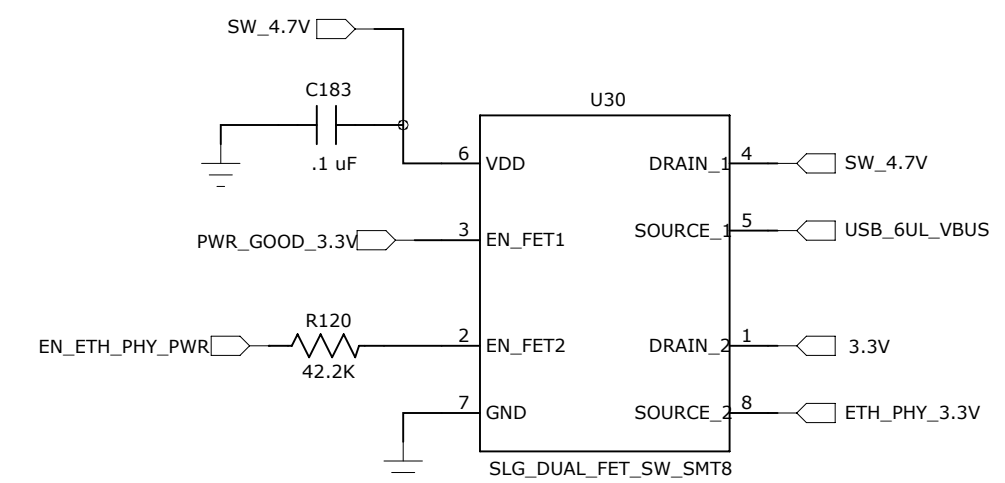


## Daughter Card Interface

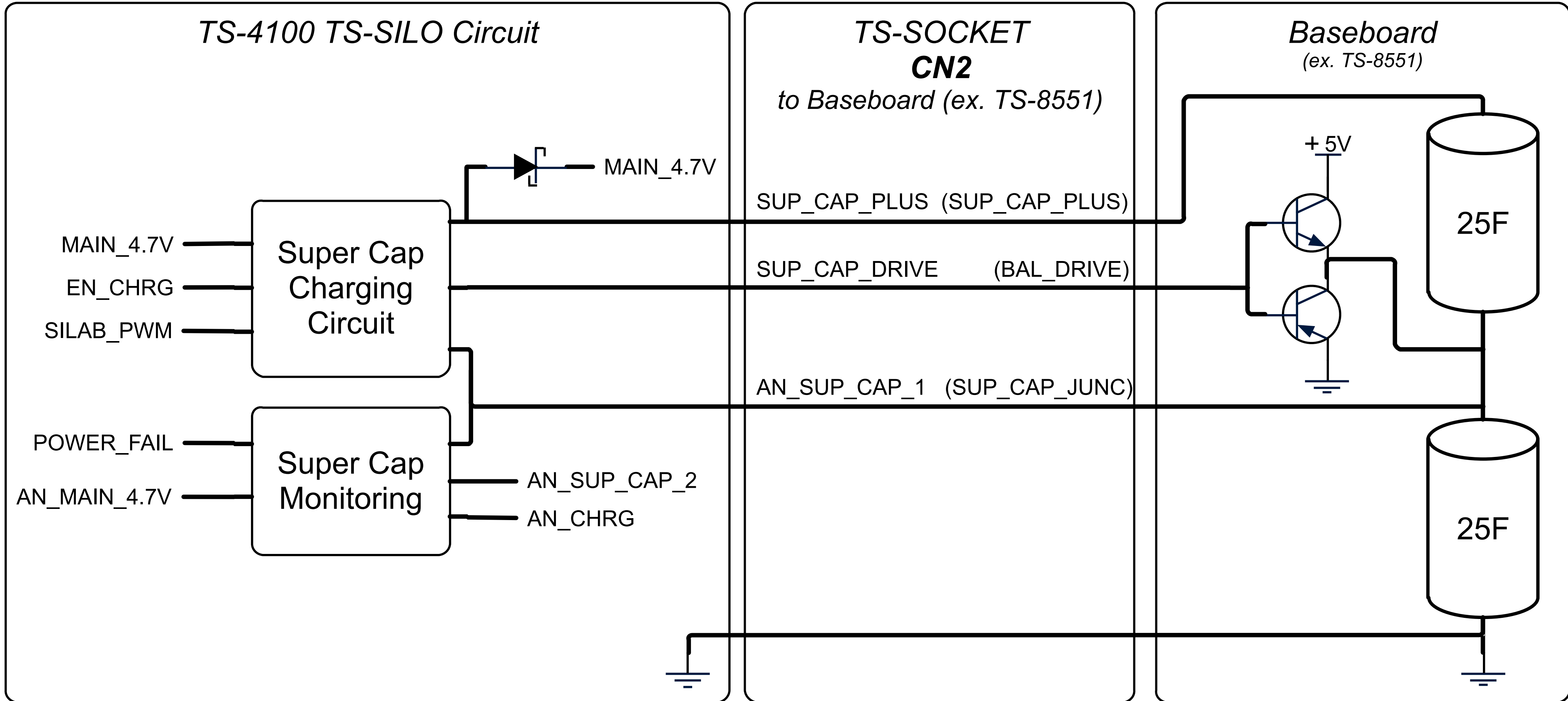
16 pin Header



## USB VBus and Eth Power Sw.



# SuperCap Power Hold

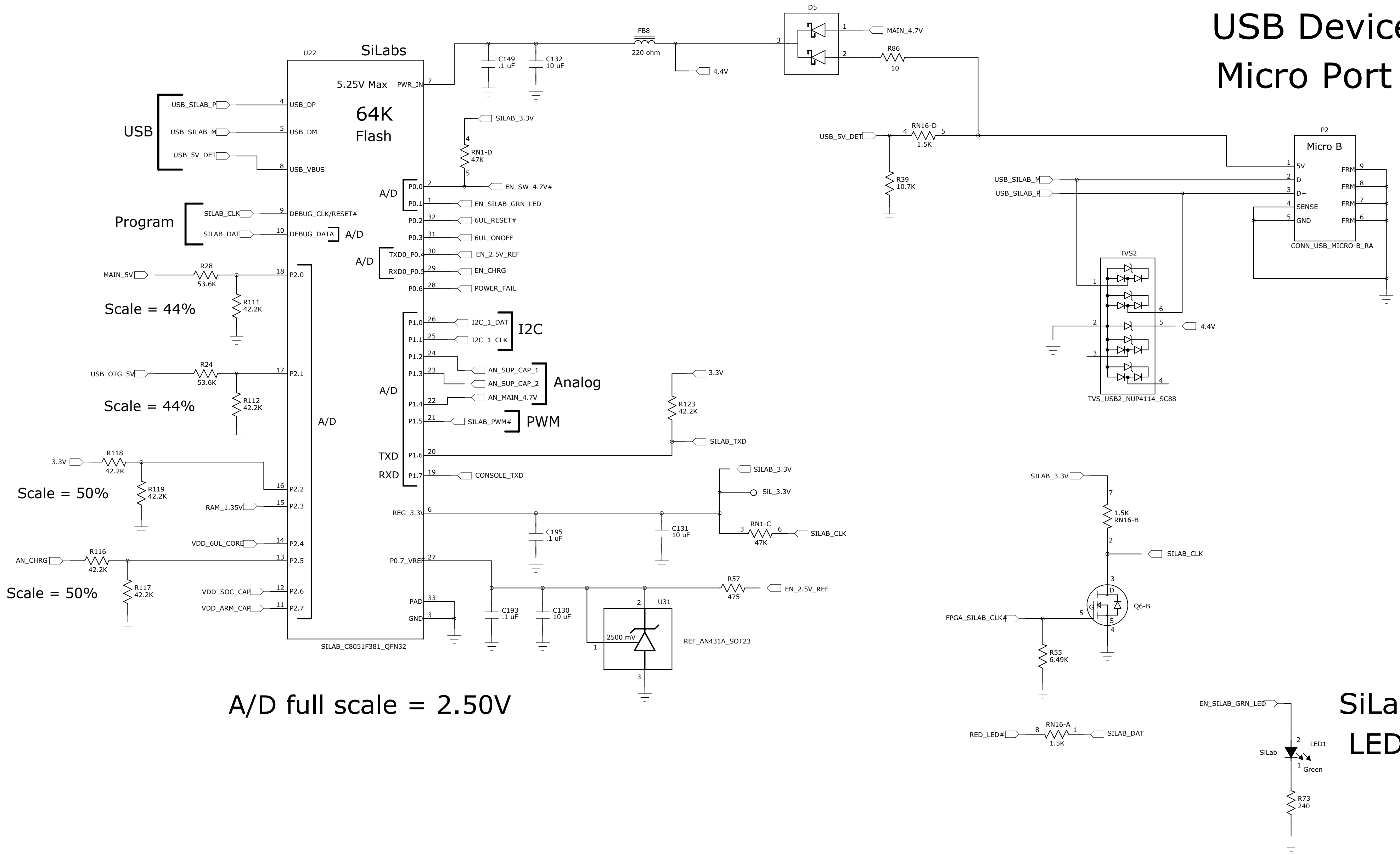


2 watt load = 400 mA from 5V  
 After Power Fail, consumption can be lowered  
 to less than 1 watt to give 20 seconds

Functions down to SuperCap = 3.5V

# USB Device Port and SiLab uC

## USB Device Micro Port



A/D full scale = 2.50V

SiLab LED

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# Two 100-pin Off-board Connectors

**⚠ All signals driving DIO on CN1 & CN2 must be powered by the 3.3V on CN2, or remain at 0V until the CN2 3.3V rail is > 3.0V**

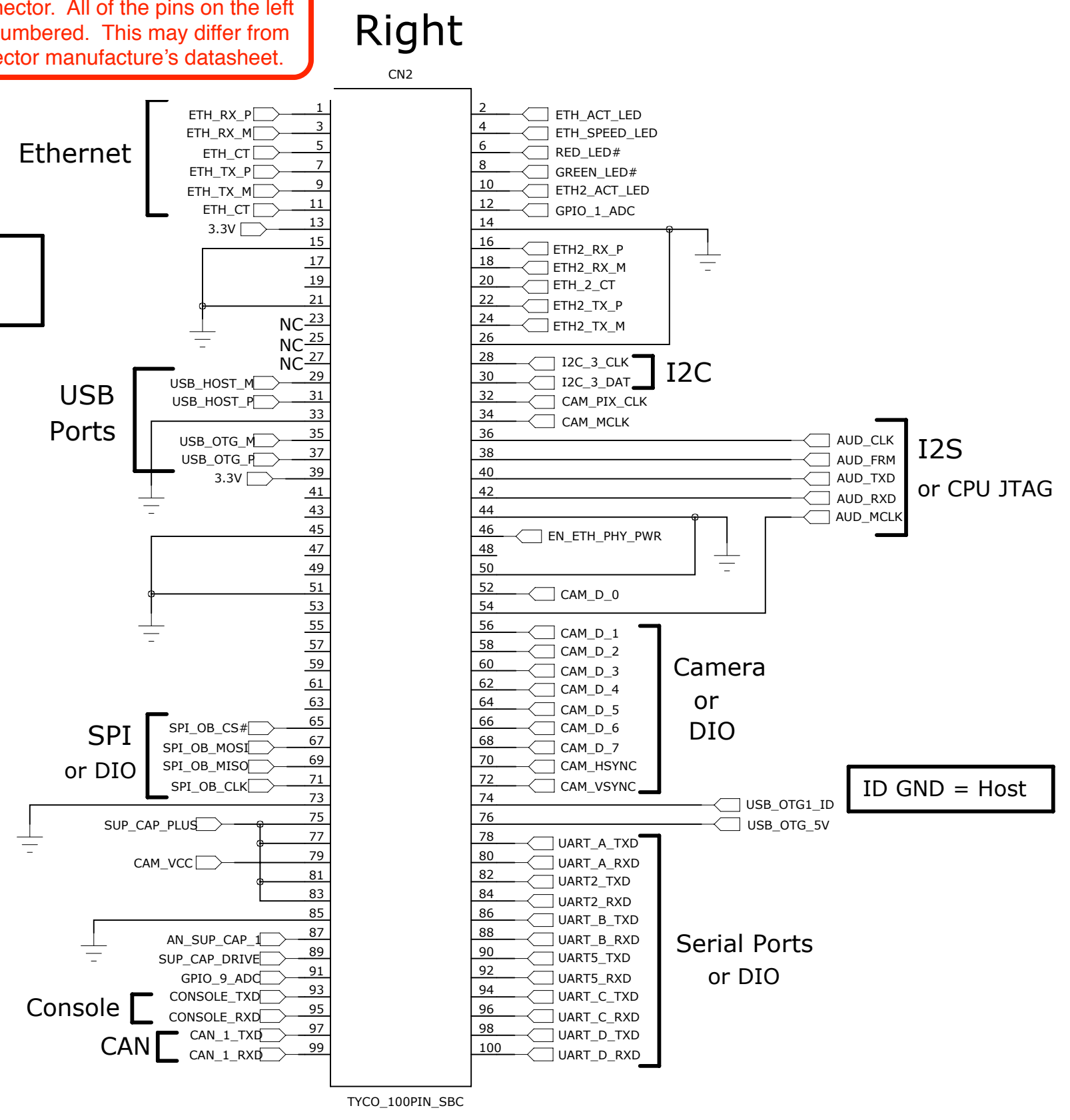
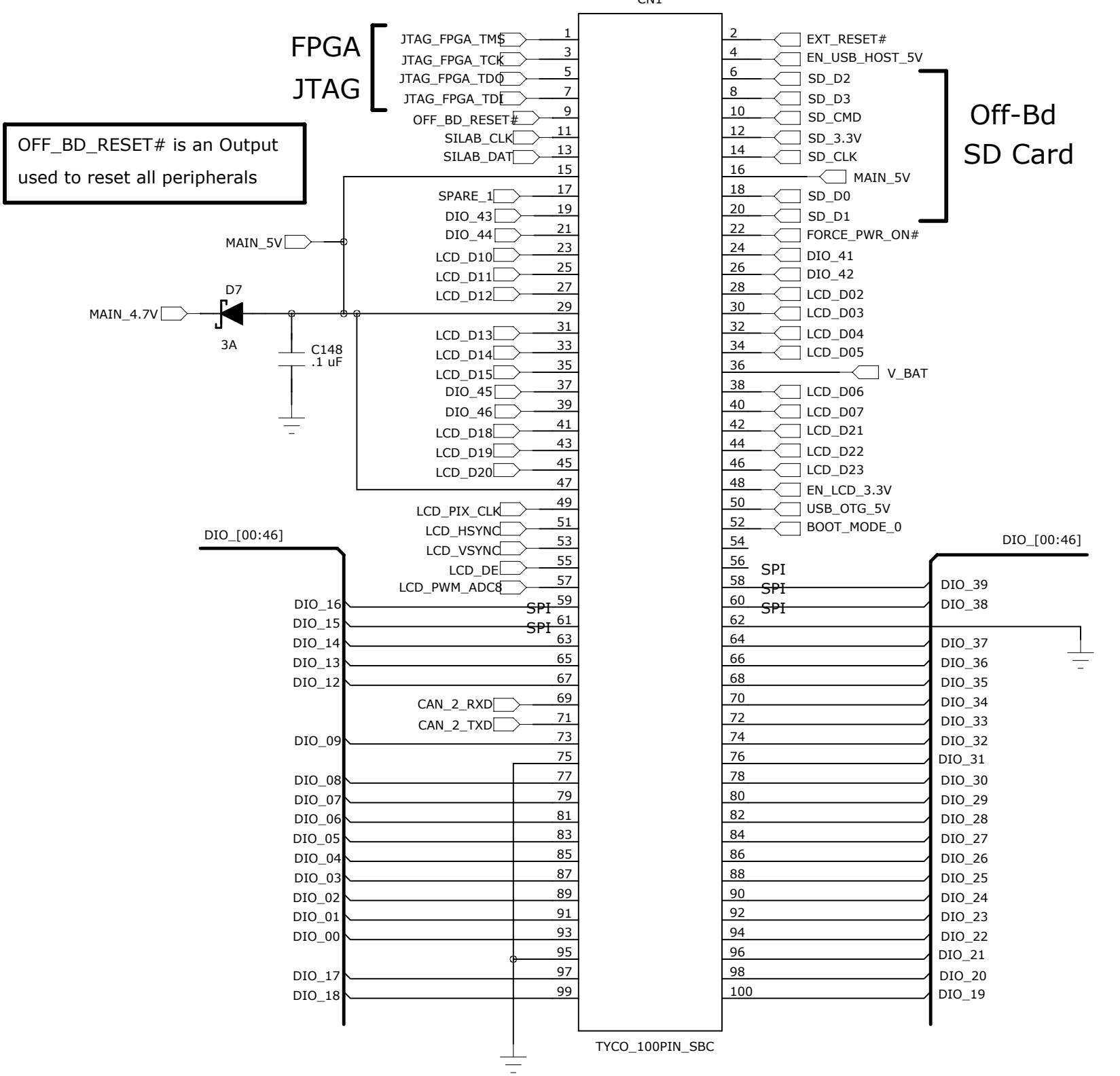
"POWER" pins supply all power to the module  
Apply 4.7V to 5.3V to these pins  
Current drain is approximately 300 mA

EXT\_RESET# is an Input  
used to reboot the CPU  
Do not drive active high  
(use open drain)

**⚠ Pin 1 is the top left corner pin on the connector. All of the pins on the left are odd numbered. This may differ from the connector manufacturer's datasheet.**

3.3V rail can supply up to 500 mA to base board

Base board should connect CN2 pins 39 and 79 together if the CAM DIO should use 3.3V levels  
If not connected, they will have 2.6V levels



## Boot Strap

DIO_20	TS-4100 Boots from
1	eMMC Flash
0	SD Card

DIO\_20 is latched prior to OFF\_BD\_RESET# deasserted

**⚠ Any I/O routed to a user accessible connector should have additional ESD protection placed on the carrier board.**

